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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re	Application of)	
Gary B. Hughes et al.)	GAU: 1734
Ser. No. 09/853,125)	Examiner:
Filed:	May 9, 2001)	George Koch
For:	FABRICATION METHOD FOR ADHESIVE)	
	PRESSURE BONDING TWO COMPONENTS)	
	TOGETHER WITH CLOSED-LOOP CONTROL)		

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Please amend this application as follows:

IN THE CLAIMS:

Enter the following claims to replace the previously submitted claims of the same respective number:

 (Amended) The method of claim 1, wherein the step of providing a first component and a second component includes the steps of providing a sensor chip assembly as the first component.

providing a sensor outp assertion as the fast components

7. (Amended) The method of claim 1, wherein the step of providing a first

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